imall

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FAIRCHILD

SEMICONDUCTOR

August 2001

FQP5N20L

FQP5N20L 200V LOGIC N-Channel MOSFET

General Description

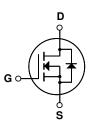
These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters, switch mode power supply, motor control.

Features

- + 4.5A, 200V, $R_{DS(on)}$ = 1.2 Ω @V_{GS} = 10 V + Low gate charge (typical 4.8 nC)
- Low Crss (typical 6.0 pF)
- · Fast switching
- · 100% avalanche tested
- Improved dv/dt capability
- · Low level gate drive requirement allowing direct opration from logic drivers





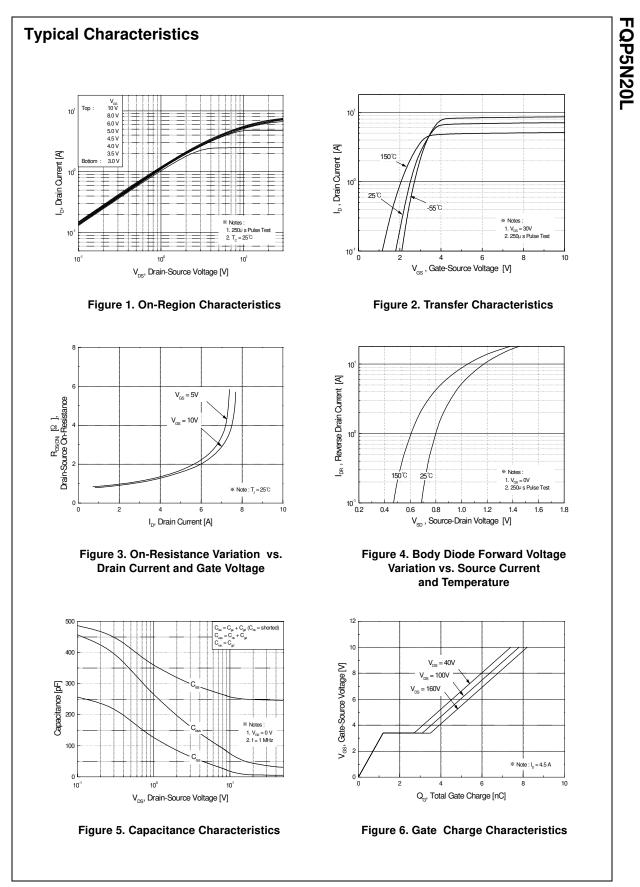
Absolute Maximum Ratings T_C = 25°C unless otherwise noted

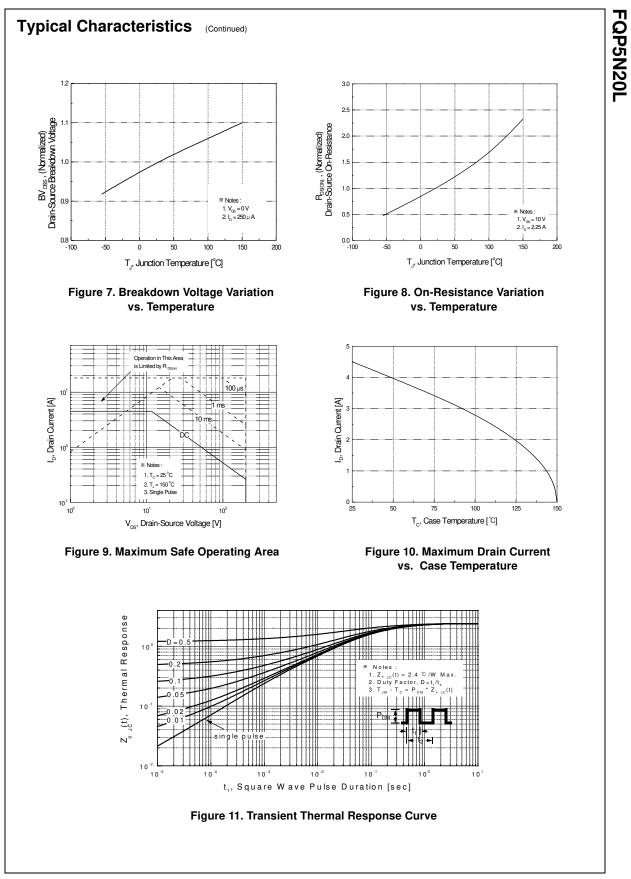
Symbol	Parameter		FQP5N20L	Units	
V _{DSS}	Drain-Source Voltage		200	V	
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		4.5	Α	
	- Continuous (T _C = 100°C)		2.8	Α	
I _{DM}	Drain Current - Pulsed	(Note 1)	18	Α	
V _{GSS}	Gate-Source Voltage		± 20	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	60	mJ	
I _{AR}	Avalanche Current	(Note 1)	4.5	А	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	5.2	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns	
P _D	Power Dissipation ($T_C = 25^{\circ}C$)		52	W	
	- Derate above 25°C		0.42	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

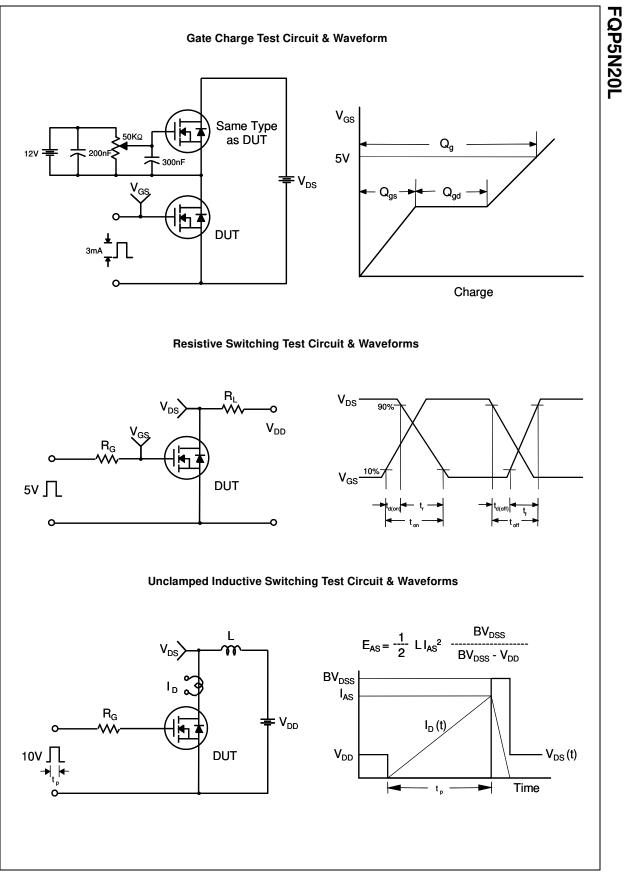
Thermal Characteristics

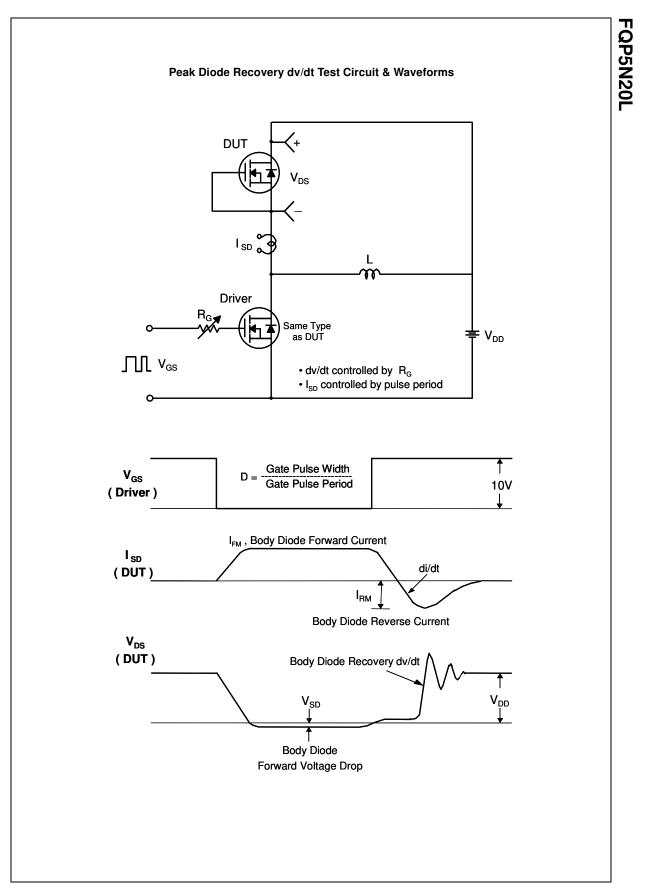
Symbol	Parameter	Тур	Max	Units	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		2.4	°C/W	
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink	0.5		°C/W	
R _{0JA} Thermal Resistance, Junction-to-Ambient			62.5	°C/W	

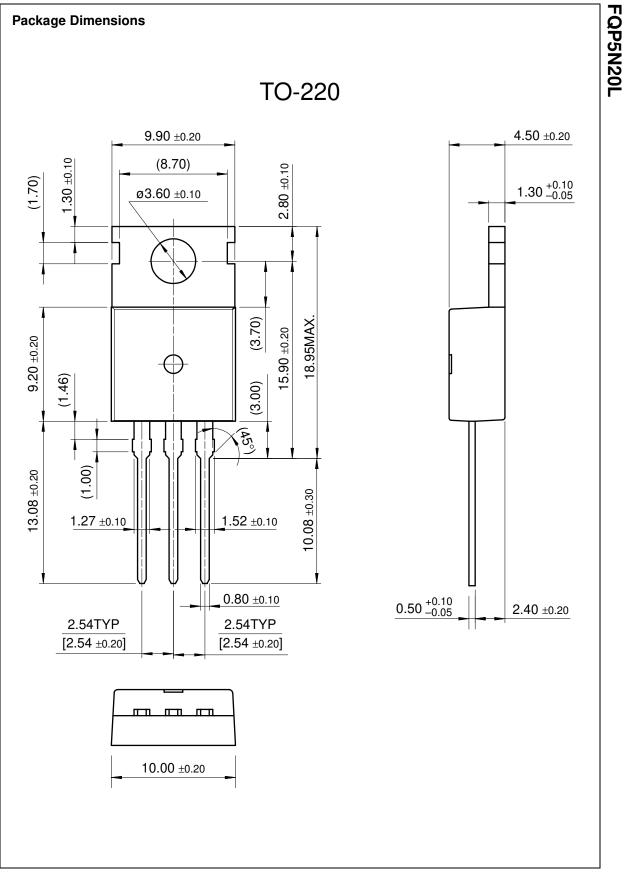
ymbol	Parameter	Test Conditions	;	Min	Тур	Max	Units
Off Cha	aracteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$		200			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu A$, Referenced	to 25°C		0.18		V/°C
DSS	7 0 1 1/1 5 1 0 1	$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}$				1	μA
	Zero Gate Voltage Drain Current	V _{DS} = 160 V, T _C = 125°C	;			10	μA
GSSF	Gate-Body Leakage Current, Forward	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				-100	nA
V _{GS(th)}	aracteristics Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA		1.0		2.0	V
R _{DS(on)}	Static Drain-Source	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2.25 \text{ A}$			0.94	1.2	
·DS(on)	On-Resistance	V _{GS} = 5 V, I _D = 2.25 A				1.25	Ω
ĴFS	Forward Transconductance	$V_{DS} = 30 \text{ V}, \text{ I}_{D} = 2.25 \text{ A}$	(Note 4)		3.6		S
Coss Crss Switch d(on) r d(off) f Qg Qgs Qqd	Reverse Transfer Capacitance ing Characteristics Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge	f = 1.0 MHz V_{DD} = 100 V, I _D = 4.5 A, R_{G} = 25 Ω V_{DS} = 160 V, I _D = 4.5 A, V_{GS} = 5 V	(Note 4, 5)	 	6 9 90 15 50 4.8 1.2 2.4	8 25 190 40 110 6.2 	pF ns ns ns nC nC nC
	Source Diode Characteristics ar	nd Maximum Rating	S				
S	Maximum Continuous Drain-Source Diode Forward Current				4.5	Α	
SM	Maximum Pulsed Drain-Source Diode F					18	Α
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 4.5 A$			-	1.5	V
•SD	Reverse Recovery Time	$V_{GS} = 0 V, I_S = 4.5 A,$ dl_ / dt = 100 A/us (Note 4)			95		ns
r Q _{rr}	· · · · · · · · , ·	dl _F / dt = 100 A/μs					











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Definition of Terms

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